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File No. 11675.127



101220600

To the Honorable Commissioner of Pate.

attached original documents or copy thereof.

1. Name of conveying party(ies):

Jigish D. Trivedi
Ravi Iyer

Additional names(s) of conveying party(ies)

Yes No

2. Name and address of receiving party(ies):

Name: Micron Technology, Inc.

Address: 8000 South Federal Way

City: Boise State/Prov.: ID

Country: US ZIP: 83707-0006

Additional name(s) & address(es)

Yes No

U.S. PTO
09/436338
11/08/99

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other

Execution Date: August 21, 1997

4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: August 21, 1997

Patent Application No. Filing date

B. Patent No.(s)

09/436338

Additional numbers

Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Bradley K. DeSandro

Registration No. 34,521

Address: WORKMAN, NYDEGGER & SEELEY

1000 Eagle Gate Tower

60 East South Temple

City: Salt Lake City State/Prov.: UT

Country: US ZIP: 84111

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

- Enclosed
- Authorized to be charged to deposit account

8. Deposit account number:

23-3178

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

JOHN N. GREAVES

Name of Person Signing

John N. Greaves
Signature

22
August 21, 1997

Date

4

Total number of pages including cover sheet, attachments, and

Workman, Nydegger & Seeley
1000 Eagle Gate Tower
60 East South Temple
Salt Lake City, Utah 84111

ASSIGNMENT

We, Jigish D. Trivedi and Ravi Iyer, of 197 E. Mallard Drive #231, Boise, Idaho 83706 and 5600 South Fuschia, Boise, Idaho 84705 respectively, have invented a method and apparatus entitled LOCAL INTERCONNET AND METHOD OF FORMATION, hereinafter called the "invention."

Preferred embodiments of said invention are disclosed in a United States patent application executed concurrently herewith by us and now identified as File No. 11675.127 of the law firm of Workman, Nydegger & Seeley, 1000 Eagle Gate Tower, 60 East South Temple, Salt Lake City, Utah 84111, and filed in the United States Patent and Trademark Office as Serial No. _____ on _____. (We hereby authorize the attorneys of Workman, Nydegger & Seeley to insert said serial number and filing date when known.)

The Assignee, Micron Technology, Inc., a corporation of the State of Delaware, having a principal place of business at 8000 South Federal Way, Boise, Idaho 83707-0006, desires to secure the entire right, title and interest in said invention.

For good and valuable consideration paid to us by the Assignee, the receipt and sufficiency of which we hereby acknowledge, WE HEREBY ASSIGN TO THE ASSIGNEE:

The entire right, title and interest in said invention in the above-identified United States patent application and in all divisions, continuations and continuations-in-part of said application, or reissues or extensions of Letters Patent or Patents granted thereon, and in all corresponding applications filed in countries

foreign to the United States, and in all patents issuing thereon in the United States and foreign countries.

The right to file foreign patent applications on said invention in its own name, wherever such right may be legally exercised, including the right to claim the benefits of the International Convention for such applications.

We hereby authorize and request the United States Commissioner of Patents and Trademarks, and such Patent Office officials in foreign countries as are duly authorized by their patent laws to issue patents, to issue any and all patents on said invention to the Assignee as the owner of the entire interest, for the sole use and behoof of the said Assignee, its successors, assigns and legal representatives.

We hereby agree, without further consideration and without expense to us, to sign all lawful papers and to perform all other lawful acts which the Assignee may request of us to make this Assignment fully effective, including, by way of example but not of limitation, the following:

Prompt execution of all original, divisional, substitute, reissue, and other United States and foreign patent applications on said invention, and all lawful documents requested by the Assignee to further the prosecution of any of such patent applications.

Cooperation to the best of our ability in the execution of all lawful documents, the production of evidence, nullification, reissue, extension, or infringement proceedings involving said invention.

This assignment and agreement shall be binding upon our heirs and legal representatives.

Dated this 21st day of August, 1997.

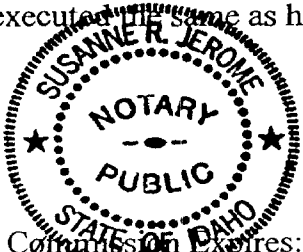
Jigish D. Trivedi
Jigish D. Trivedi

STATE OF IDAHO)

: ss.

COUNTY OF Ada)

On 21st August, 1997, before me personally appeared Jigish D. Trivedi, known to me to be the person described and who signed the foregoing Assignment in my presence and acknowledged under oath before me that he has read the same and know the contents thereof and that he executed the same as his free act and deed and for the purposes set forth therein.



Susanne R. Jerome
NOTARY PUBLIC
Residing at Middleton, ID

My Commission Expires:

3/12/2002

Dated this 21st day of August, 1997.

Ravi Iyer
Ravi Iyer

STATE OF IDAHO)

: ss.

COUNTY OF Ada)

On 21st August, 1997, before me personally appeared Ravi Iyer, known to me to be the person described and who signed the foregoing Assignment in my presence and acknowledged under oath before me that he has read the same and know the contents thereof and that he executed the same as his free act and deed and for the purposes set forth therein.

Susanne R. Jerome
NOTARY PUBLIC
Residing at Middleton, ID

My Commission Expires:

3/12/2002

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